

## Silicon Epitaxial Planar Diode

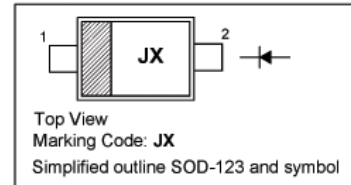
High Voltage Switching Diode

### Features

- Fast switching speed
- High Conductance
- High Reverse Breakdown Voltage

### PINNING

PIN	DESCRIPTION
1	Cathode
2	Anode

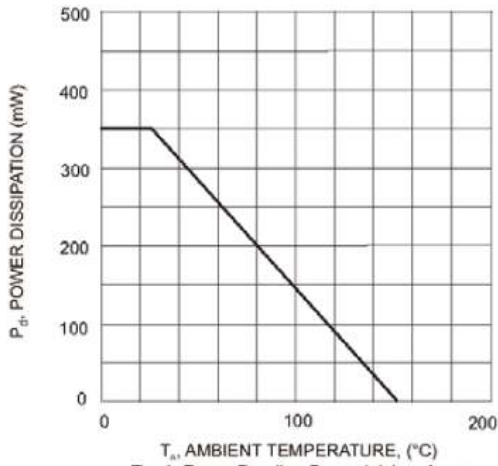


### Absolute Maximum Ratings ( $T_a = 25\text{ }^\circ\text{C}$ )

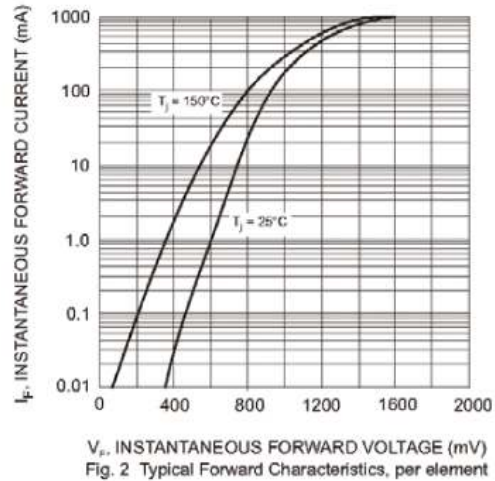
Parameter	Symbol	Value	Unit
Repetitive Peak Reverse Voltage	$V_{RRM}$	350	V
Working Peak Reverse Voltage	$V_{RWM}$	300	V
Reverse Voltage	$V_R$	300	V
Continuous Forward Current	$I_F$	225	mA
Peak Repetitive Forward Current	$I_{FRM}$	625	mA
Non-Repetitive Peak Forward Surge Current	$I_{FSM}$	4	A
		1	
Power Dissipation	$P_d$	350	mW
Operating and Storage Temperature Range	$T_j, T_{stg}$	- 65 to + 150	$^\circ\text{C}$

### Characteristics at $T_a = 25\text{ }^\circ\text{C}$

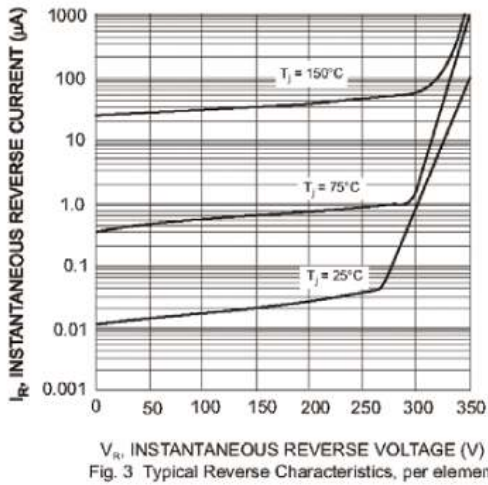
Parameter	Symbol	Min.	Max.	Unit
Forward Voltage at $I_F = 20\text{ mA}$ at $I_F = 100\text{ mA}$ at $I_F = 200\text{ mA}$	$V_F$	-	0.87	V
		-	1	
		-	1.25	
Reverse Current at $V_R = 240\text{ V}$ at $V_R = 240\text{ V}, T_j = 150\text{ }^\circ\text{C}$	$I_R$	-	100	nA
		-	100	$\mu\text{A}$
Reverse Breakdown Voltage at $I_R = 100\text{ }\mu\text{A}$	$V_{(BR)R}$	350	-	V
Total Capacitance at $V_R = 0, f = 1\text{ MHz}$	$C_T$	-	5	pF
Reverse Recovery Time at $I_F = I_R = 30\text{ mA}, i_{rr} = 0.1 I_R, R_L = 100\text{ }\Omega$	$t_{rr}$	-	50	ns



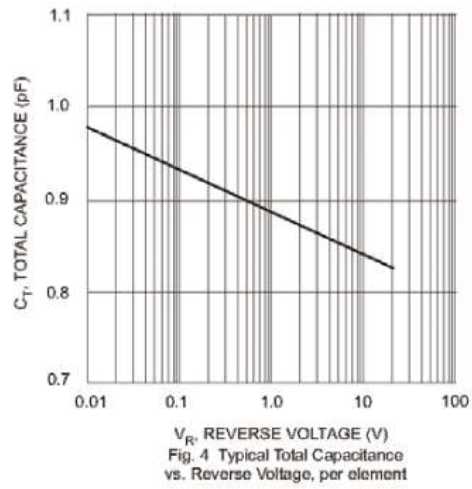
$T_a$ , AMBIENT TEMPERATURE, (°C)  
Fig. 1 Power Derating Curve, total package



$V_F$ , INSTANTANEOUS FORWARD VOLTAGE (mV)  
Fig. 2 Typical Forward Characteristics, per element



$V_R$ , INSTANTANEOUS REVERSE VOLTAGE (V)  
Fig. 3 Typical Reverse Characteristics, per element

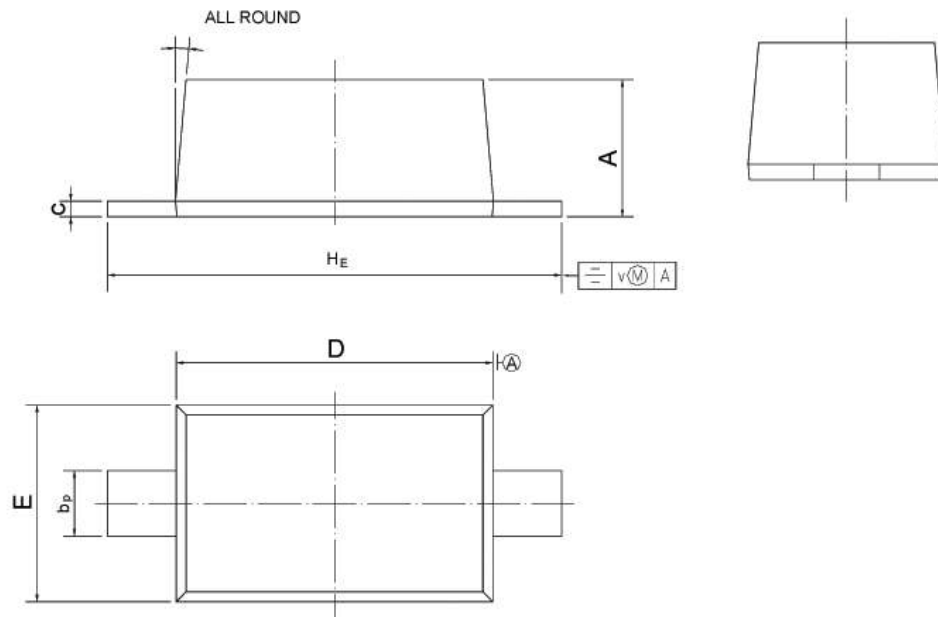


$V_R$ , REVERSE VOLTAGE (V)  
Fig. 4 Typical Total Capacitance vs. Reverse Voltage, per element

PACKAGE OUTLINE

Plastic surface mounted package; 2 leads

SOD-123



UNIT	A	b <sub>p</sub>	c	D	E	H <sub>E</sub>	v	
mm	1.15 1.05	0.6 0.5	0.135 0.100	2.7 2.6	1.65 1.55	3.85 3.55	0.2	5°